

Part No.: E12LG2C-O

### Features:

- Highest Flux
- High reliability and Very long operating life (up to 100K hours)
- Low voltage DC operated
- More Energy Efficient than Incandescent and most Halogen lamps
- NO UV
- Superior ESD protection
- RoHS Compliant

## **Typical Applications:**

- Reading lights (car, bus, aircraft)
- Portable (flashlight, bicycle)
- Automotive Exterior (Stop-Tail-Turn, CHMSL, Mirror Side Repeat)
- Decorative



#### NOTE:

- All dimensions are millimeters.
- Tolerance is  $\pm 0.1$ mm unless noted





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## Absolute maximum ratings (Ta = $25^{\circ}$ C)

Parameter	Symbol	Tast Condition	Value		Linit
		Test Condition	Min.	Max.	Unit
DC Forward Current	IF			350	mA
Peak Pulse Current	Ipeak	Duty=0.1mS, 1kHz		500	mA
Power Dissipation	Pd			1.25	W
LED Junction Temperature	Tj			120	°C
Operating Temperature	Topr		-25	+100	°C
Storage Temperature	Tstr		-40	+120	°C
ESD Sensitivity		HBM	8000		V
Soldering Temperature			260°C for 5 Seconds max		

## Electrical and optical characteristics $(Ta = 25^{\circ}C)$

Parameter	Symbol	Test Condition	Value			Lloit
			Min.	Тур.	Max.	Onit
Forward Voltage	VF		3.0	3.3	4.0	V
Luminous Flux	Фγ		60	70		lm
Viewing Angle	2 θ 1/2-X	IF = 350mA		110		Deg.
Viewing Angle	2 θ 1/2-Y			160		Deg.
Dominant Wavelength	$\lambda$ d		520		530	nm

## Luminous Flux Bins (Ta = 25°C) Unit: Im

Bin	J	K	L
Min	60	70	80
Max	70	80	100

#### Note

- 1. Flux is measured with an accuracy of  $\pm 15\%$
- 2. CCT is measured with an accuracy of  $\pm$  200K
- 3. Forward Voltage is measured with an accuracy of  $\pm 0.15V$



## **Heat Plate Soldering Condition**

1. Soldering Process for Solder Paste



Put MCPCB on Heat Plate until Solder Paste melt. Put Emitter on MCPCB. Take the MCPCB out The Solder Paste sould be melted within 10 seconds. from Heat Plate within 10 seconds. Take out MCPCB out from Heat Plate within 10 seconds.



### 2. Soldering Process for Solder Wire





Put Emitter on MCPCB. Take the MCPCB out from Heat Plate within 10 seconds.

- Heat plate temperature: 230°C max for Lead Solder and 260°C
- max for Lead-Free Solder.
- When soldering, do not put stress on the LEDs during heating.
- After soldering, do not warp the circuit board.



### 3. Manual Hand Soldering



#### Place Emitter on the MCPCB



#### Use Soldering Iron to solder the leads of Emtter within 5 seconds

- For prototype builds or small series production runs it possible to place and solder the emitters by hand.
- Solder tip temperature: 230°C max for Lead Solder and 260°C max for Lead-Free Solder.
- Avoiding damage to the emitter or to the MCPCB dielectric layer. Damage to the epoxy layer can cause a short circuit in the array.
- Do not let the solder contact from solder pad to back-side of MCPCB. This one will cause a short circuit and damage emitter.